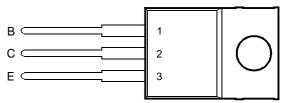
- Designed for Complementary Use with TIP125, TIP126 and TIP127
- 65 W at 25°C Case Temperature
- 5 A Continuous Collector Current
- Minimum h<sub>FE</sub> of 1000 at 3 V, 3 A

#### TO-220 PACKAGE (TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRACA

# absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT	
	TIP120		60	
Collector-base voltage (I <sub>E</sub> = 0)	TIP121	$V_{CBO}$	80	V
	TIP122		100	
	TIP120		60	
Collector-emitter voltage (I <sub>B</sub> = 0)	TIP121	$V_{CEO}$	80	V
	TIP122		100	
Emitter-base voltage	$V_{EBO}$	V <sub>EBO</sub> 5		
Continuous collector current			5	Α
Peak collector current (see Note 1)	I <sub>CM</sub>	8	Α	
Continuous base current	I <sub>B</sub>	0.1	Α	
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)			65	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)			2	W
Unclamped inductive load energy (see Note 4)			50	mJ
Operating junction temperature range			-65 to +150	°C
Storage temperature range	T <sub>stg</sub>	-65 to +150	°C	
Lead temperature 3.2 mm from case for 10 seconds	T <sub>L</sub>	260	°C	

NOTES: 1. This value applies for  $t_p \leq 0.3$  ms, duty cycle  $\leq 10\%.$ 

- 2. Derate linearly to 150°C case temperature at the rate of 0.52 W/°C.
- 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
- 4. This rating is based on the capability of the transistor to operate safely in a circuit of: L = 20 mH,  $I_{B(on)}$  = 5 mA,  $R_{BE}$  = 100  $\Omega$ ,  $V_{BE(off)}$  = 0,  $R_{S}$  = 0.1  $\Omega$ ,  $V_{CC}$  = 20 V.

# TIP120, TIP121, TIP122 NPN SILICON POWER DARLINGTONS

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# electrical characteristics at 25°C case temperature

PARAMETER			TEST CONDITIO	ONS	MIN TYP	MAX	UNIT	
	Collector-emitter			TIP120	60			
V <sub>(BR)CEO</sub>	breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	TIP121	80			V
		(see Note 5)		TIP122	100			
	Collector-emitter	V <sub>CE</sub> = 30 V	I <sub>B</sub> = 0	TIP120			0.5	
I <sub>CEO</sub>	cut-off current	$V_{CE} = 40 V$	$I_B = 0$	TIP121			0.5	mA
		$V_{CE} = 50 V$	$I_B = 0$	TIP122			0.5	
	Collector cut-off	V <sub>CB</sub> = 60 V	I <sub>E</sub> = 0	TIP120			0.2	
I <sub>CBO</sub>	current	$V_{CB} = 80 V$	$I_E = 0$	TIP121			0.2	mA
	Current	V <sub>CB</sub> = 100 V	$I_E = 0$	TIP122			0.2	
I <sub>EBO</sub>	Emitter cut-off	V <sub>EB</sub> = 5 V	I <sub>C</sub> = 0				2	mΑ
EBO	current	AER - O A	0				_	11.5 (
h <sub>FE</sub>	Forward current	$V_{CE} = 3 V$	$I_C = 0.5 A$	(see Notes 5 and 6)	1000			
"FE	transfer ratio	$V_{CE} = 3 V$	$I_C = 3 A$		1000			
Vor	Collector-emitter	$I_B = 12 \text{ mA}$	$I_C = 3 A$	(see Notes 5 and 6)			2	V
V <sub>CE(sat)</sub>	saturation voltage	$I_B = 20 \text{ mA}$	$I_C = 5 A$	(See Notes o and o)			4	·
V <sub>BE</sub>	Base-emitter	V <sub>CE</sub> = 3 V	I <sub>C</sub> = 3 A	(see Notes 5 and 6)			2.5	V
* BE	voltage	VCE - 3 V	10 = 3 A	(500 110103 5 and 6)			2.0	V
V <sub>EC</sub>	Parallel diode	I <sub>F</sub> = 5 A	I <sub>B</sub> = 0	(see Notes 5 and 6)		_	3.5	V
	forward voltage	'E = 3 A	'R - 0	(See Notes 5 and 6)			0.0	V

NOTES: 5. These parameters must be measured using pulse techniques,  $t_p$  = 300  $\mu$ s, duty cycle  $\leq$  2%.

#### thermal characteristics

PARAMETER			MAX	UNIT
R <sub>0JC</sub> Junction to case thermal resistance			1.92	°C/W
R <sub>θJA</sub> Junction to free air thermal resistance			62.5	°C/W

# resistive-load-switching characteristics at 25°C case temperature

	PARAMETER	TEST CONDITIONS †		MIN	TYP	MAX	UNIT	
t <sub>on</sub>	Turn-on time	I <sub>C</sub> = 3 A	$I_{B(on)} = 12 \text{ mA}$	$I_{B(off)} = -12 \text{ mA}$		1.5		μs
t <sub>off</sub>	Turn-off time	$V_{BE(off)} = -5 V$	$R_L = 10 \Omega$	$t_p = 20 \ \mu s, \ dc \le 2\%$		8.5		μs

 $<sup>\</sup>begin{tabular}{ll} $\uparrow$ Voltage and current values shown are nominal; exact values vary slightly with transistor parameters. \end{tabular}$ 

### PRODUCT INFORMATION

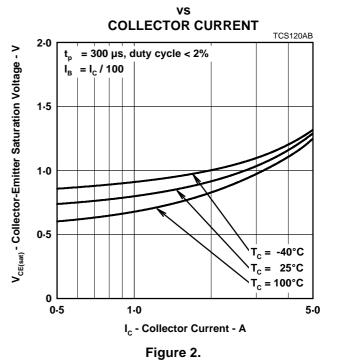
<sup>6.</sup> These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

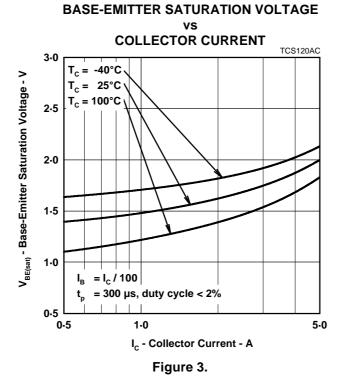
#### **TYPICAL CHARACTERISTICS**

# **TYPICAL DC CURRENT GAIN COLLECTOR CURRENT** TCS120AA 40000 $T_c = -40^{\circ}C$ 25°C $T_c = 100$ °C h<sub>FE</sub> - Typical DC Current Gain 10000 1000 3 V = 300 µs, duty cycle < 2% 100 0.5 1.0 5-0 Ic - Collector Current - A

Figure 1.

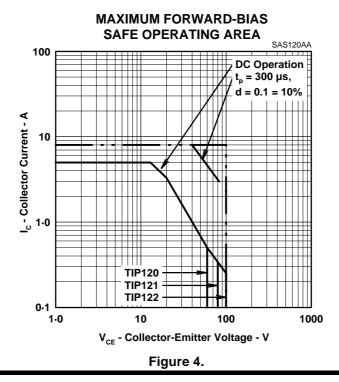
### **COLLECTOR-EMITTER SATURATION VOLTAGE**





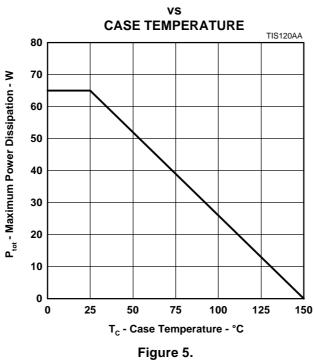


#### **MAXIMUM SAFE OPERATING REGIONS**



#### THERMAL INFORMATION

#### **MAXIMUM POWER DISSIPATION**



# PRODUCT INFORMATION

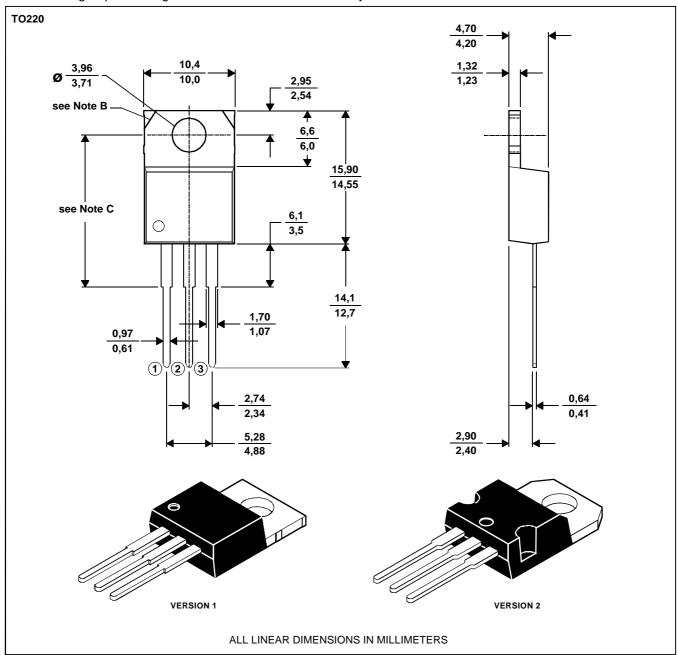
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#### **MECHANICAL DATA**

#### **TO-220**

## 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm. Version 2, 17.6 mm. **MDXXBE** 

#### PRODUCT INFORMATION

# TIP120, TIP121, TIP122 NPN SILICON POWER DARLINGTONS

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